

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	SPD03N60C3	**Issued**	27. April 2022
MA#	MA005729959		
Package	PG-TO252-3-35	**Weight***	322.67 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.326	0.72	0.72	7207	7207
leadframe	inorganic material	phosphorus	7723-14-0	0.053	0.02		165	
	non noble metal	iron	7439-89-6	0.177	0.05		549	
	non noble metal	copper	7440-50-8	176.899	54.83	54.90	548232	548946
wire	non noble metal	aluminium	7429-90-5	0.648	0.20	0.20	2009	2009
encapsulation	organic material	carbon black	1333-86-4	0.409	0.13		1268	
	plastics	epoxy resin	-	15.952	4.94		49439	
	inorganic material	silicondioxide	60676-86-0	119.984	37.18	42.25	371847	422554
leadfinish	non noble metal	tin	7440-31-5	3.834	1.19	1.19	11881	11881
solder	non noble metal	tin	7440-31-5	0.048	0.01		148	
	noble metal	silver	7440-22-4	0.060	0.02		185	
	non noble metal	lead	7439-92-1	2.281	0.71	0.74	7070	7403
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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